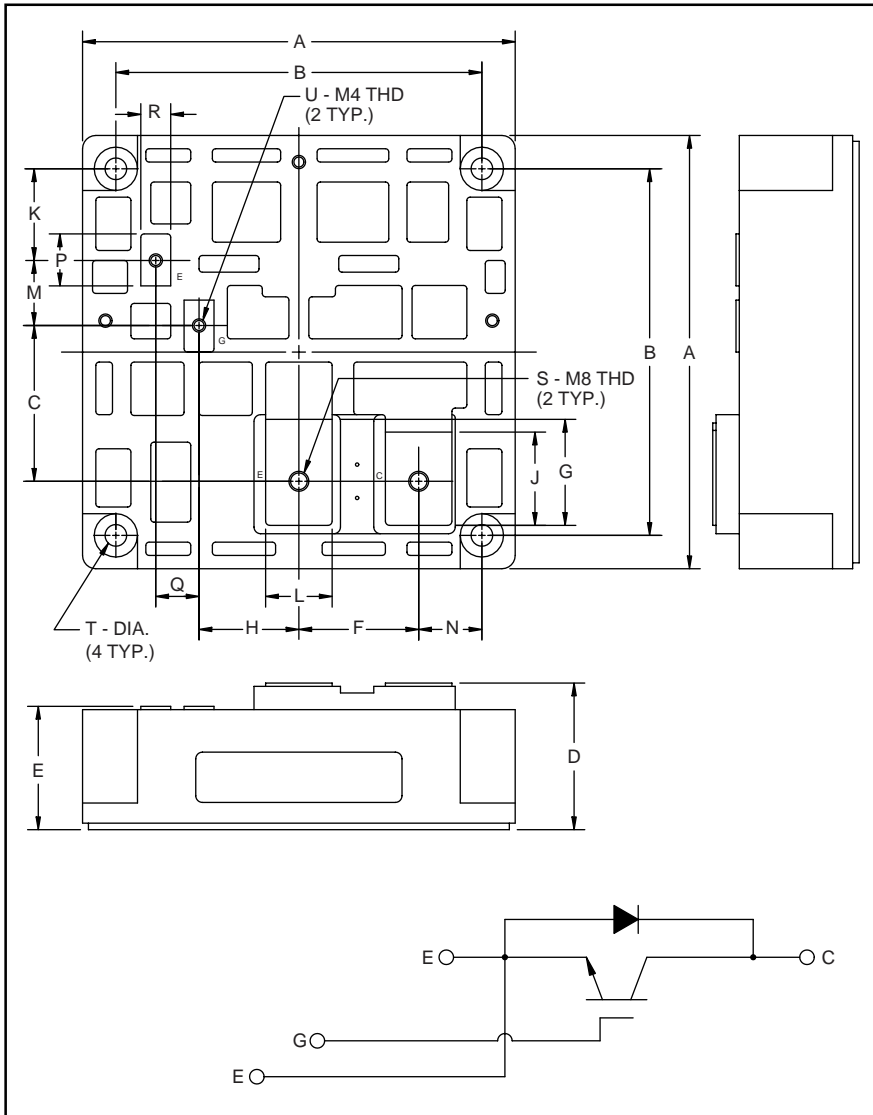


MITSUBISHI IGBT MODULES

CM1000HA-28H

HIGH POWER SWITCHING USE
INSULATED TYPE



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	5.12	130.0
B	4.33±0.01	110.0±0.25
C	1.840	46.75
D	1.73+0.04/-0.02	44.0+1.0/-0.5
E	1.46+0.04/-0.02	37.0+1.0/-0.5
F	1.42	36.0
G	1.25	31.8
H	1.18	30.0
J	1.10	28.0
K	1.08	27.5

Dimensions	Inches	Millimeters
L	0.79	20.0
M	0.77	19.5
N	0.75	19.0
P	0.61	15.6
Q	0.51	13.0
R	0.35	9.0
S	M8 Metric	M8
T	0.26 Dia.	Dia. 6.5
U	M4 Metric	M4



Description:

Mitsubishi IGBT Modules are designed for use in switching applications. Each module consists of one IGBT in a single configuration with a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- High Frequency Operation
- Isolated Baseplate for Easy Heat Sinking

Applications:

- AC Motor Control
- Motion/Servo Control
- UPS
- Welding Power Supplies

Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM1000HA-28H is a 1400V (V_{CES}), 1000 Ampere Single IGBT Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	1000	28

CM1000HA-28H

HIGH POWER SWITCHING USE
INSULATED TYPEAbsolute Maximum Ratings, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Ratings	Symbol	CM600HU-12H	Units
Junction Temperature	T_j	-40 to 150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E SHORT)	V_{CES}	1400	Volts
Gate-Emitter Voltage (C-E SHORT)	V_{GES}	± 20	Volts
Collector Current ($T_c = 25^\circ\text{C}$)	I_C	1000	Amperes
Peak Collector Current ($T_j \leq 150^\circ\text{C}$)	I_{CM}	2000*	Amperes
Emitter Current** ($T_c = 25^\circ\text{C}$)	I_E	1000	Amperes
Peak Emitter Current**	I_{EM}	2000*	Amperes
Maximum Collector Dissipation ($T_c = 25^\circ\text{C}$)	P_c	5800	Watts
Mounting Torque, M8 Main Terminal	–	8.83~10.8	$\text{N} \cdot \text{m}$
Mounting Torque, M6 Mounting	–	1.96~2.94	$\text{N} \cdot \text{m}$
Mounting Torque, M4 Terminal	–	0.98~1.47	$\text{N} \cdot \text{m}$
Weight	–	1600	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	V_{iso}	2500	V_{rms}

* Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed $T_{j(max)}$ rating.

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

Static Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{CE} = V_{CES}, V_{GE} = 0V$	–	–	2.0	mA
Gate Leakage Current	I_{GES}	$V_{GE} = V_{GES}, V_{CE} = 0V$	–	–	0.5	μA
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 100\text{mA}, V_{CE} = 10V$	5.0	6.5	8.0	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 1000A, V_{GE} = 15V$	–	3.3	4.5	Volts
		$I_C = 1000A, V_{GE} = 15V, T_j = 150^\circ\text{C}$	–	3.1	–	Volts
Total Gate Charge	Q_G	$V_{CC} = 800V, I_C = 1000A, V_{GE} = 15V$	–	5355	–	nC
Emitter-Collector Voltage	V_{EC}	$I_E = 10000A, V_{GE} = 0V$	–	–	4.0	Volts

* Pulse width and repetition rate should be such that device junction temperature rise is negligible.

Dynamic Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	C_{ies}		–	–	200	nF
Output Capacitance	C_{oes}	$V_{GE} = 0V, V_{CE} = 10V$	–	–	70	nF
Reverse Transfer Capacitance	C_{res}		–	–	40	nF
Resistive	Turn-on Delay Time	$t_{d(on)}$	–	–	800	ns
Load	Rise Time	t_r	–	–	2000	ns
Switching Times	Turn-off Delay Time	$t_{d(off)}$	–	–	1200	ns
	Fall Time	t_f	–	–	650	ns
Diode Reverse Recovery Time	t_{rr}	$I_E = 1000A, di_E/dt = -2000A/\mu\text{s}$	–	–	300	ns
Diode Reverse Recovery Charge	Q_{rr}	$I_E = 1000A, di_E/dt = -2000A/\mu\text{s}$	–	10.5	–	μC

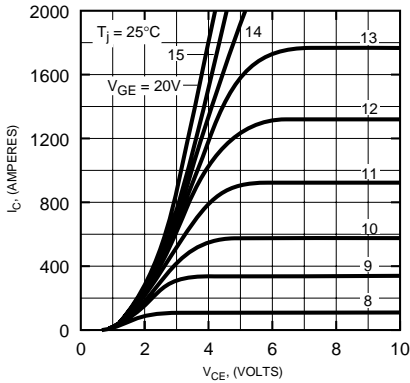
Thermal and Mechanical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Per IGBT	–	–	0.022	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Per FWDi	–	–	0.050	$^\circ\text{C}/\text{W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	–	–	0.018	$^\circ\text{C}/\text{W}$

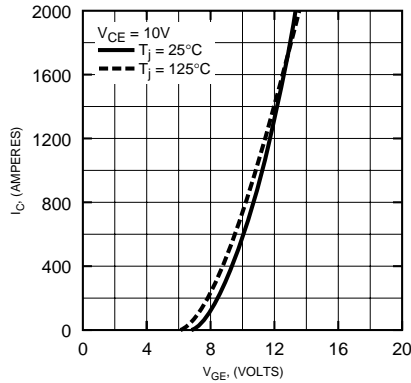
CM1000HA-28H

HIGH POWER SWITCHING USE
INSULATED TYPE

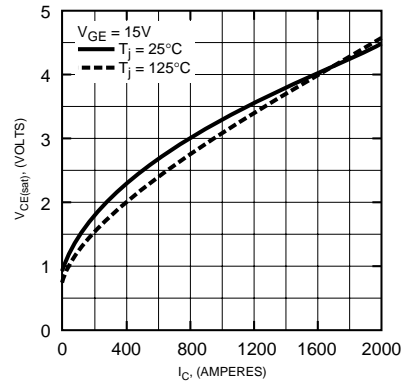
OUTPUT CHARACTERISTICS
(TYPICAL)



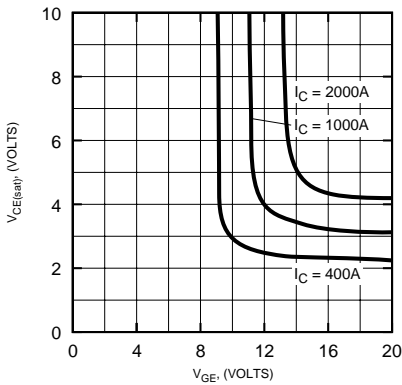
TRANSFER CHARACTERISTICS
(TYPICAL)



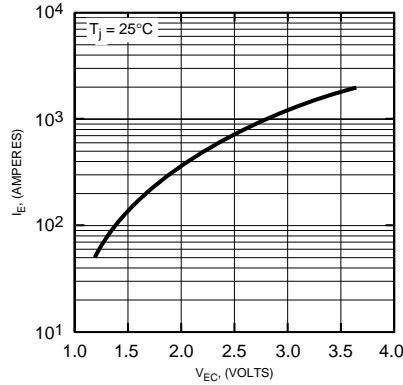
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS
(TYPICAL)



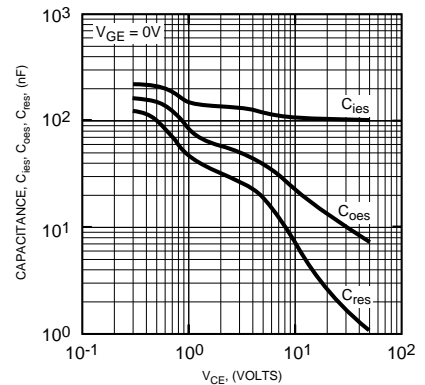
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS
(TYPICAL)



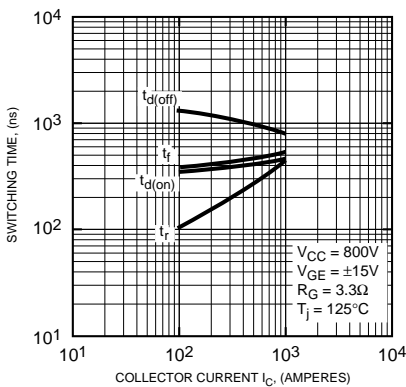
FREE-WHEEL DIODE FORWARD CHARACTERISTICS
(TYPICAL)



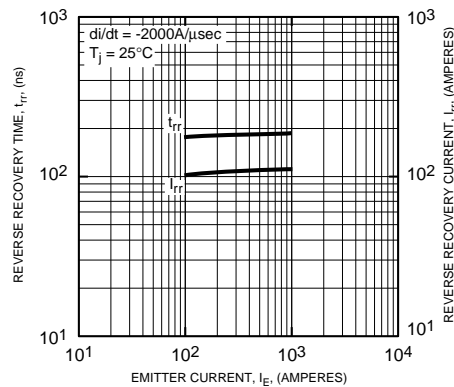
CAPACITANCE VS. VCE
(TYPICAL)



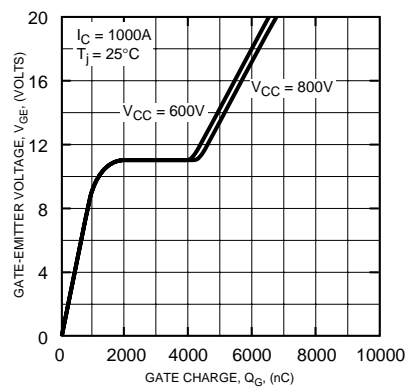
HALF-BRIDGE SWITCHING CHARACTERISTICS
(TYPICAL)



REVERSE RECOVERY CHARACTERISTICS
(TYPICAL)



GATE CHARGE, VGE



CM1000HA-28H

HIGH POWER SWITCHING USE
INSULATED TYPE

